



Part Description:

70° Red Super Flux LED



Features

- High Luminance / High Light Output
- Low Thermal Resistance
- Low Profile
- Meet SAE/ECE/JIS Automotive

Color Requirements

- Design for High Current Operation
- Pb free & RoHS Compliant Product

Applications

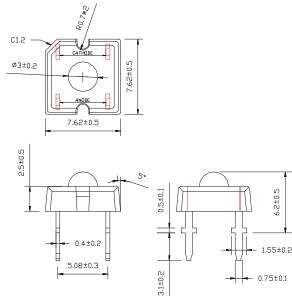
- Automotive Exterior Lighting
- Electronic Signs and Signals
- Specialty Lighting
- Decoration
- Channel Letter

Benefits

Fewer LED Requirement

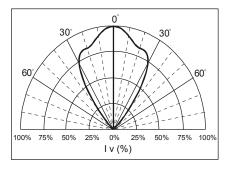
Lower Application Cost

Outline Drawings



5.2±0.5

Beam Pattern



Notes:

1. All dimensions are in millimeter.

- 2. Tolerance is ± 0.20 mm unless otherwise noted.
- 3. Protruded resin under bottom surface of epoxy is 1.5mm max.
- 4. Lead spacing is measured where the leads emerge from

the package.



Absolute Maximum Ratings at T_A = 25°C

Parameter	Symbol	Max.	Unit
Average Forward Current ^{[a] [c]}	$I_{\rm F}$	70	mA
Peak Forward Current ^[b]	I peak	100	mA
Reverse Voltage	V _R	10	V
Power Dissipation	P _D	210	mW
Current Linearity vs. Ambient Temperature	TCI	-0.87	mA/°C
LED Junction Temperature	T _J	125	°C
Operating Temperature Range ^[c]	T _{OPR}	-40°C ~+100°C	
Storage Temperature Range	T _{STO}	-40°C ~+100°C	
Lead Soldering Condition [3mm(.118") away from epoxy]	T _{SOL}	260° C / 5 seconds	

Notes : [a] Design of heat dissipation should be considered.

[b] Duty Ratio=1/10, Pulse Width=0.1ms.

[c] The allowable operating current at different operation temperature, please take reference from Fig. 4 page 4.

Electrical and Optical Characteristics at T_A = 25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Total Luminous Flux	Φv	3850	7000		mlm	I _F =70mA
Luminous Intensity / Total Flux	$Iv/\Phi v$		0.90		mcd / mlm	I _F =70mA
Viewing Angle	$2 heta_{1/2}$		70		Deg	I _F =70mA
Total Included Angle ^[1]	heta 0.9		110		Deg	I _F =70mA
Dominant Wavelength	λ_{D}	619	623	630	nm	I _F =70mA
Spectral Half Width	Δλ		25		nm	I _F =70mA
Forward Voltage	\mathbf{V}_{F}	2.0	2.4	3.0	V	I _F =70mA
Reverse Current	I _R			100	μA	$V_R=10V$
Thermal Resistance θj-a		300 (Тур.)			°C/W	I _F =70mA
Thermal Resistance θj-pin		125 (Typ.)		°C/W	I _F =70mA	

Rank Combination

	Dominant Wavelength λ₀ (nm) @l _F =70mA			Total Flux Φ∨ (mlm) @l _F =70mA				orward / _F (v) @			
min	max	Code	min	max	Code	min	max	Code	min	max	Code
619	625	RB	3850	5400	2F*	2.0	2.2	B	2.8	3.0	F
625	630	R7	5400	7600	2G	2.2	2.4	С	-	-	-
-	_	_	7600	10000	2H*	2.4	2.6	D	-	-	-
-	-	-	10000	15000	2J*	2.6	2.8	Ε	-	-	-

Note: 1. Viewing angle 0.9V is the included angle at which 90% of total luminous flux is captured.

2. All of rank combinations which include luminous intensity, dominant wavelength, and forward voltage will be included in every shipment.

3. Measurement Uncertainty of the Total flux: $\pm 15\%$

4. Measurement Uncertainty of the Dominant Wavelength: ±1nm

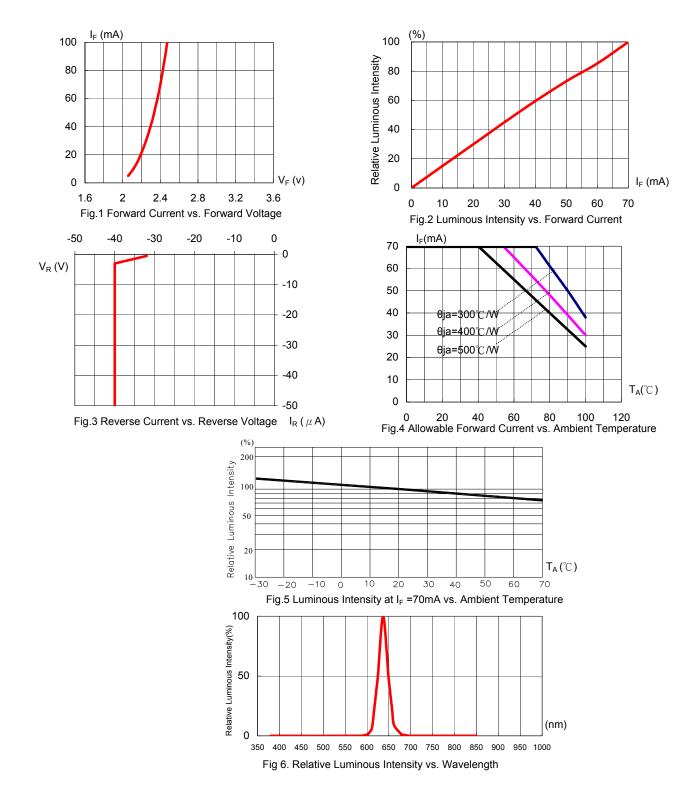
5. Measurement Uncertainty of the Voltage: $\pm 0.05V$

6. [*] Bin with less distribution



Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)



Note: The data shown above are typical curves. Every LED component may have some variations of characteristics.

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Reliability Test

EOI's LED lamps are checked by reliability test based on MIL standards.

Classi- fication	Test Item	Standard Test Method	Test Conditions	Duration	Unit	Acc / Rej Criteria	Result
Life Test	Operation Life Test (OLT)	MIL-STD-750D Method 1026.3	$T_A=25^{\circ}C$, $I_F=70mA$ *	1000 Hrs	100	0 / 1	Pass
	High Temperature Storage (HTS)	MIL-STD-750D Method 1032.1	T _A =100°C	1000 Hrs	100	0 / 1	Pass
Environment Test	Low Temperature Storage (LTS)	MIL-STD-750D Method 1032.1	$T_A = -40^{\circ}C$	1000 Hrs	100	0 / 1	Pass
	Temp. & Humidity with Bias (THB)	MIL-STD-750D Method 103B	T _A =85°C , Rh=85% I _F =45mA **	500 Hrs	100	0 / 1	Pass
Envir	Thermal Shock Test (TST)	MIL-STD-750D Method 1056.1	0°C ~ 100°C 2min 2min	100 cycles	100	0 / 1	Pass
	Temperature Cycling Test (TCT)	MIL-STD-750D Method 1051.5	-40°C ~ 25°C~ 100°C ~ 25°C 30min 5min 30min 5min	100 cycles	100	0 / 1	Pass
Test	Solderability	MIL-STD-750D Method 2026.4	235±5℃,5 sec.	1 time	20	0 / 1	Pass
Mechanical Test	Resistance to Soldering Heat	MIL-STD-750D Method 2031.1	260±5℃,5 sec.	1 time	20	0 / 1	Pass
Mec	Lead Integrity	MIL-STD-750D Method 2036.3	Load 2.5N (0.25kgf) $0^{\circ} \sim 90^{\circ} \sim 0^{\circ}$, bend	3 times	20	0 / 1	Pass

1. Test Conditions, Acceptable Criteria & Results:

Remark : (*) I_{F} =70mA for AlInGaP chip ; I_{F} =50mA for InGaN chip

(**) I_F =45mA for AlInGaP chip ; I_F =30mA for InGaN chip

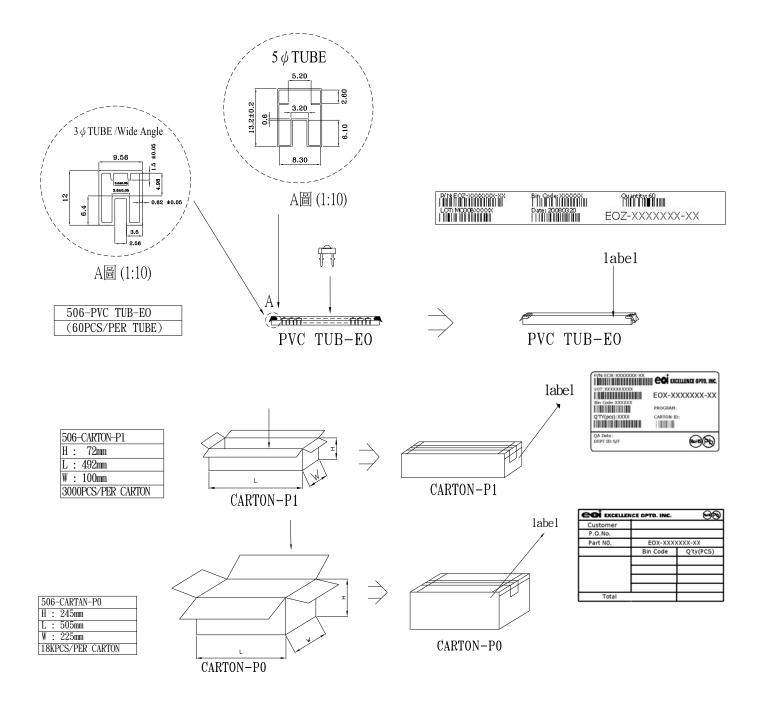
2. Failure Criteria ($T_A = 25^{\circ}C$):

Test Item	Symbol	Test Conditions	Criteria for Judgment				
	Cymbol		Min.	Max.			
Luminous Intensity	I_V	$I_F = 20 \text{ mA}$	LSL×0.5 **				
Forward Voltage	$V_{\rm F}$	$I_F = 20 \text{ mA}$		USLx1.1 *			

(*) USL : Upper Standard Level , (**) LSL : Lower Standard Level



Shipment Package





Precaution of Application

1. Circuit layout

Due to the forward voltage of LED will vary with temperature and its driving current, the current-limited protective circuit should be considered in the LED circuit design.

When LEDs are arrayed as parallel circuit, different inherent resistance of LED will cause unbalance current. The unbalanced driving current which exists in every parallel circuit may make LED to be driven at different power. Therefore, the LED driven at higher power may be damaged by over driving current, and the LED driven at lower power may be dimmer than the others.

To solve this situation, a suitable resistor is recommended to put in series with each LED circuit. The resistor will limit and balance the driving current which flows through every parallel circuits.

2. Electric Static Discharge (ESD) Protection



All kinds of LED materials, such as GaP, AlGaAs, AllnGaP, GaN, or InGaN chips, are STATIC SENSITIVE device. ESD protection or surge voltages shall be considered and taken care in the initial design stage, and whole production process.

The following protection is recommended:

(1) A wrist band or an anti-electrostatic glove shall be used when handling the LEDs

(2) All devices, equipment and machinery must be properly grounded

If LED is damaged by ESD or surge voltage, damaged LED may show some unusual characteristics. It may appear leakage current, and LED does not emit at low current.

And when using microscope to inspect damaged LED chip at low driving current, it may have some black dots within the emitting area.

3. Lead Forming

The leads should not be bent or cut at the point of 3mm or shorter than 3mm from the base of the epoxy bulb while forming the leads. It's recommended to cut or form the lead by tooling made rather than by hand operation.

Do not apply any bending stress to the base of the lead, and don't cause any stress after mounting the LED lamp on PCB. The stress to the base may damage the LED's characteristics, or cause deterioration of the epoxy resin. This will hurt and degrade the LEDs.

4. Storage

It is recommended to store the LED in the following conditions:

(1) Shelf life in original package: 12 months at $T_A < 40^{\circ}C$ and humidity < 60%RH.

(2) After the package is opened and the LED should be kept in the following environment:

Humidity (Hum.): 60%RH Max.

Temperature (T_A): 5°C ~ 30°C (41°F ~ 86°F)

Assembly duration: within 168 hours, after LED is out of original package.

The LED should be used completely as soon as possible. If some of LED are not used, it's recommended to keep LED at humidity $\leq 60\%$ RH in original package.

Although the leads of LED lamp are platted with pure tin to protect leads from corrosion, devices should be subjected to wave soldering, or equivalent process as soon as possible, after the package box is opened.

Please avoid rapid transitions in ambient temperature, especially in high humidity environment where condensation can occur.

5. Soldering

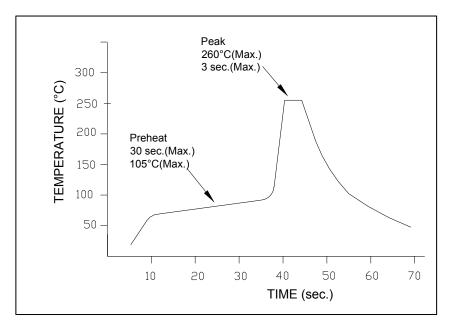
Soldering heat may damage the LED. Careful attention should be paid during soldering process and PCB assembly. In order to eliminate the stress of heat shock, please solder the LEDs no close than 3mm form the base of the epoxy bulb.



Recommended soldering condition:

	Wave Soldering	Manual Solder Dipping	Hand soldering by iron		
Pre-heat Temperature	e-heat Temperature 105°C Max.				
Pre-heat Time	30 sec. Max.	-			
Peak Temperature 260°C Max.		260°C Max.	350°C Max.		
Dwell Time	3 sec. Max.	5 sec. Max.	3 sec. Max.		

Wave Solder Temperature Profile



Never take next process until the component is cooled down to room temperature after soldering. It's banned to load any stress on the resin during soldering. If it's necessary to clamp the LED bulbs to help soldering, it is important to minimize the mechanical stress on the LEDs.

The manual soldering process is not recommended for quality consideration. When it is absolutely necessary, the LEDs may be mounted in this fashion but the user will assume responsibility for any problems.



6. Cleaning

An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended to clean the LED bulbs, after soldering process, if cleaning is necessary. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

It is not recommended to use unspecified chemical liquids as cleaning material for cleaning the LED. It's also not recommended to use ultrasonic power to clean the LED device. The chemical and ultrasonic power could harm the LED devices.

7. Others

- (1) The light output of LED might injure human eyes, directly look at the LED without protection is prohibited.
- (2) LED lamp is very sensitive to heat. Thermal design of the end product will decide the performance of LED lamps. It's necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- (3) Every piece of LED will be sorted and LEDs with the same binning grade will be taped into the same reel or put into the same bag. It is recommended to use the same bin-grade LED to assembly the unit module. This will ensure the LED unit module with good uniformity of brightness, hue, and so on.

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Terms and Condition

- 1. EOI warrants all sold LEDs which conform to the specifications approved by the customers.
- **2.** Any LED supplied by EOI is found not conform to the specifications that both parties agreed upon, customer should claim within 90 days of receipt. EOI will repair or replace the LEDs at EOI's option.
- **3.** EOI will not hold any responsibility for the failed LEDs, which are caused by mishandling or misusing the LEDs exceeding the operating conditions that EOI suggested.
- **4.** EOI's LED products are designed and manufactured for general electronic equipment (such as household appliances, communication equipment, office equipment, electronic instrumentation and so on). If customer's application requires exceptional quality or reliability, which might concern human safety, it is recommended to consult with EOI in advance.
- **5.** All the information published is considered to be reliable. However, EOI does not assume any liability arising out of the application or use of any product described herein. EOI's liability for defective LED lamps shall only be limited to replacement, in no event shall EOI be liable for consequential damages or loss.
- **6.** EOI and customer shall both confirm the specifications herein, and all quality related matters will base on the specifications both parties agreed upon.
- **7.** Any modification of the design or manufacturing process taken place, which will affect the characteristics, performance or reliability of LED, customer's approval will be required.
- **8.** This specification approval sheet is an agreement of shipment specification. Please sign it back and keep the copies in two parties. If customers don't sign it back, it is regarded as completely agree with the terms and conditions and also approve of this approval sheet.

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